isola

TerraGreen®

Halogen-free, Very Low Loss Material

TerraGreen[®] laminate materials exhibit exceptional electrical properties which are very stable over a broad frequency and temperature range.

TerraGreen[®] is engineered for such highperformance applications as power amplifier boards for LTE base stations, internet infrastructure and cloud computing. TerraGreen[®] features a Dielectric Constant (Dk) that is stable between -55°C and 125°C, up to 20 GHz.

TerraGreen[®] is a lead-free assembly material and is easy to process. This high-performance material utilizes a shortlamination cycle; the product is easy to drill, does not require plasma desmear, and the prepreg shelf life is similar to FR-4 materials. TerraGreen[®] is suitable for high-layer count, highspeed digital backplanes and is compatible with Isola's FR-4 materials for hybrid designs.

 $\mathsf{TerraGreen}^{\circledast}$ meets UL 94 V-0 and is halogen free.

Product Attributes

High Thermal Reliability , High Speed Digital , Halogen Free

Typical Market Applications

Computing, Storage & Peripherals , Networking & Communication Systems

High Thermal Reliability

Data Sheet Tg 200°C Td 390°C Dk 3.44 Df 0.0039

UL - File Number E41625

Last Updated December 7, 2017 Revision No: 10

Product Features

Product Availability

TerraGreen[®] Typical Values

Last Updated Dec 7, 2017

Property		Typical Value	Units	Test Method
			Metric (English)	IPC-TM-650 (or as noted)
Glass Transition Temperature (Tg) by DSC		200	°C	2.4.25C
Decomposition Temperature (Td) by TGA @ 5% weight loss		390	°C	2.4.24.6
Time to Delaminate by TMA (Copper removed)	A. T260 B. T288	60	Minutes	2.4.24.1
Z-Axis CTE	50 to 260°C, (Total Expansion)	2.9	%	2.4.24C
X/Y-Axis CTE	Pre-Tg	16	ppm/°C	2.4.24C
Thermal Conductivity		0.32	W/mK	ASTM E1952
Thermal Stress 10 sec @ 288ºC (550.4ºF)	A. Unetched B. Etched	Pass	Pass Visual	2.4.13.1
Dk, Permittivity	A. @ 2 GHz B. @ 5 GHz C. @ 10 GHz	3.44	_	2.5.5.5
Df, Loss Tangent	A. @ 2 GHz B. @ 5 GHz C. @ 10 GHz	0.0039	_	Bereskin Stripline
Volume Resistivity	C-96/35/90	1.33 x 10 ⁷	MΩ-cm	2.5.17.1
Surface Resistivity	C-96/35/90	1.33 x 10 ⁵	MΩ	2.5.17.1
Dielectric Breakdown		45.4	kV	2.5.6B
Arc Resistance		139	Seconds	2.5.1B
Electric Strength (Laminate & laminated prepreg)		45 (1133)	kV/mm (V/mil)	2.5.6.2A
Comparative Tracking Index (CTI)		In Testing	Class (Volts)	UL 746A ASTM D3638
Peel Strength	A. 0.5 oz. EDC foil B. 1 oz. EDC foil	0.88 (5.0)	N/mm (lb/inch)	2.4.8C
Flexural Strength	A. Length direction B. Cross direction	75,500 60,000	ksi	2.4.4B
Tensile Strength	A. Length direction B. Cross direction	40,000 39,000	ksi	ASTM D3039
Young's Modulus	A. Length direction B. Cross direction	3125 2745	ksi	ASTM D790-15e2
Poisson's Ratio	A. Length direction B. Cross direction	0.238 0.231	_	ASTM D3039
Moisture Absorption		0.05	%	2.6.2.1A
Flammability (Laminate & laminated prepreg)		V-0	Rating	UL 94
Max Operating Temperature		130	°C	UL 796

The data, while believed to be accurate and based on analytical methods considered to be reliable, is for information purposes only. Any sales of these products will be governed by the terms and conditions of the agreement under which they are sold.

